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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/622,484	07/21/2003	Michael Setton	015290-755	4980	
75	7590 01/26/2006			EXAMINER	
Peter K. Skiff BURNS, DOANE, SWECKER & MATHIS, L.L.P.			POMPEY, RON EVERETT		
P.O. Box 1404			ART UNIT	PAPER NUMBER	
Alexandria, VA 22313-1404			2812		
			DATE MAILED: 01/26/2006		

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)				
Office Action Summary		10/622,484	SETTON, MICHAEL				
		Examiner	Art Unit				
		Ron E. Pompey	2812				
Period fo	The MAILING DATE of this communication app or Reply	ears on the cover sheet with the	correspondence address				
WHIC - Exte after - If NC - Failt Any	ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DANSIONS of time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. Operiod for reply is specified above, the maximum statutory period vere to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing ed patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATIO 36(a). In no event, however, may a reply be to vill apply and will expire SIX (6) MONTHS fror , cause the application to become ABANDON	N. imely filed In the mailing date of this communication. ED (35 U.S.C. § 133).				
Status							
1)  🔀	Responsive to communication(s) filed on 14 No.	ovember 2005	•				
· —		action is non-final.					
3)	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is						
,	closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
Disposit	ion of Claims						
4) 🛛	Claim(s) 38-47 and 49-55 is/are pending in the	application.					
	4a) Of the above claim(s) is/are withdrawn from consideration.						
	5)⊠ Claim(s) <u>40-43</u> is/are allowed.						
6)⊠	6)⊠ Claim(s) <u>38-39, 44-47 and 49-55</u> is/are rejected.						
7)	Claim(s) is/are objected to.						
8)[	Claim(s) are subject to restriction and/or election requirement.						
Applicati	ion Papers						
9) ☐ The specification is objected to by the Examiner.							
10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.							
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).							
	Replacement drawing sheet(s) including the correct	ion is required if the drawing(s) is ol	bjected to. See 37 CFR 1.121(d).				
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.							
Priority ι	ınder 35 U.S.C. § 119						
12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) ☐ All b) ☐ Some * c) ☐ None of:							
	1. Certified copies of the priority documents have been received.						
	2. Certified copies of the priority documents have been received in Application No						
	3. Copies of the certified copies of the priority documents have been received in this National Stage						
application from the International Bureau (PCT Rule 17.2(a)).							
* 8	See the attached detailed Office action for a list	of the certified copies not receiv	ed.				
Attachmen	t(s)						
_	e of References Cited (PTO-892)	4) Interview Summary	y (PTO-413)				
2) 🔲 Notic	e of Draftsperson's Patent Drawing Review (PTO-948)	Paper No(s)/Mail D	Pate				
	nation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) r No(s)/Mail Date	5) Motice of Informal ( 6) Other:	Patent Application (PTO-152)				

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#### **DETAILED ACTION**

## Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 38-39 and 44-55 are rejected under 35 U.S.C. 103(a) as being unpatentable over Pfiester (US 5,200,352) in view of Wu (5,880,508) in further view of admitted prior art or Ohiwa et al. (4,947,081) in further view of Shinriki et al. (US 5,292,673).

Pfiester discloses the limitations of:

forming an interfacial layer (14, fig. 1A), comprising silicon nitride or silicon oxynitride, on a silicon semiconductor substrate; and

forming a gate electrode of an electrically conductive material on the interfacial layer;

source and drain regions (32, fig. 1E) that are adjacent the gate electrode(col. 2, ln. 48 – col. 4, ln. 33); and

forming spacer (20, fig. 1A) adjacent to the gate electrode and on an upper surface of the interfacial layer (col. 5, Ins. 30-41).

3. Pfiester reads on the claims as applied above, but does not disclose the claimed limitation(s) below of:

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forming a high dielectric constant layer (8, fig. 1) on the interfacial layer;

forming spacers adjacent to the gate electrode and on an upper surface of the high dielectric constant layer by depositing a film selected from the group consisting of phosphosilicate glass, oxides and nitrides over the entire surface of the device and then anisotropic etching the film;

forming a high dielectric constant layer (2, fig. 5a) on the interfacial layer, the comprises a material that is selected from the group consisting of  $Ta_2O_5$ ,  $Ta_2(O_{1-x}N_x)_5$  wherein x ranges from greater than 0 to 0.6, a solid solution of  $(Ta_2O_5)_t$  -  $(ZrO_2)_{1-t}$  wherein t ranges from about 0.9 to less than 1, and a solid solution of  $(Ta_2O_5)_u$ - $(HfO_2)_{1-u}$  wherein u ranges from about 0.9 to less than 1 and a solid solution  $(Ta_2O_5)_s$ - $(Al_2O_3)_{1-s}$  wherein s ranges from 0.9 to less than 1 wherein the interfacial layer separates the high dielectric constant layer from the substrate;

having a gate width of less than 0.3 micron covering the high dielectric constant layer;

wherein the interfacial layer and the high dielectric constant layer separates the spacers from the substrate; and

further comprising forming second spacers on the interfacial layer adjacent to the spacers formed in step (e) and to the high dielectric constant layer by depositing a film selected from the group consisting of phosphosilicate glass, oxides, and nitrides over the entire surface of the device and then anisotropic etching the film..

However,

a. Wu discloses the above claimed limitations regarding:

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forming a high dielectric constant layer (8, fig. 1) on the interfacial layer (6, fig. 1), the comprises a material that is selected from the group consisting of  $Ta_2O_5$ , wherein the interfacial layer comprises silicon nitride or silicon oxynitride;

wherein the interfacial layer separates the high dielectric constant layer from the substrate; and

having a gate width of less than 0.3 micron covering the high dielectric constant layer (column 1, ln. 25).

Therefore, it would have been obvious to one of ordinary skill in the art at the time of the invention to combine Pfiester with Wu, because the high dielectric constant layer provides for a gate insulator layer that reduces hot carrier effect; and the gate width of less than 0.3 micron take up less wafer real estate, which means more devices can be formed on one wafer. Note: that because the spacers are formed after the gate oxide in Pfiester the spacers would also be formed on the high dielectric layer when combining Wu with Pfiester.

b. Pfiester and Wu, fail to disclose the limitations of:

wherein the high dielectric layer comprises one of the following,  $Ta_2(O_{1-x} N_x)_5$  wherein x ranges from greater than 0 to 0.6.

However the admitted prior art (APA), on page 6, line 24 –26, or Ohiwa, column 2, lines 45-58, discloses that a high dielectric layer can be formed of the above compositions. Also, Ohiwa discloses that tantalum oxynitride in the claimed range is art recognized equivalent to tantalum pentoxide.

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Also, in applicants' specification, page 7, line 25 – page 8, line 3, states that it is conventional for photoresist/lithography techniques to form a gate pattern that will form the line width of a gate less than 0.3 micron.

Therefore it would have been obvious to one of ordinary skill in the art to combine the admitted prior art (APA) and/or Ohiwa with Wu, because the above listed materials are art equivalent high dielectric material with  $Ta_2O_5$  of the Wu reference.

c. Pfiester, Wu, APA and Ohiwa, fail to disclose the limitations of:

forming spacers adjacent to the gate electrode and on an upper surface of the high dielectric constant layer by depositing a film selected from the group consisting of phosphosilicate glass, oxides and nitrides over the entire surface of the device and then anisotropic etching the film; and

further comprising forming second spacers on the interfacial layer adjacent to the spacers formed in step (e) and to the high dielectric constant layer by depositing a film selected from the group consisting of phosphosilicate glass, oxides, and nitrides over the entire surface of the device and then anisotropic etching the film.

However, Shinriki does disclose forming a spacer (12, fig. 7b) adjacent to the gate electrode on an upper surface of the high dielectric layer by deposition and a second spacer (17, fig. 7b; wherein on means touching) on the interfacial layer adjacent to the spacers formed in step (e) by deposition.

Therefore it would have been obvious to one of ordinary skill in the art to combine the Pfiester, Wu, APA and Ohiwa with Shinriki because forming a layer by deposition will requires less time and processing will be quicker.

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## Allowable Subject Matter

4. Claims 40-43 are allowed.

5. The following is a statement of reasons for the indication of allowable subject matter: the prior art of record, either singly or in combination, fails to disclose the limitations of: wherein the high dielectric layer comprises one of the following compositions, a solid solution of  $(Ta_2O_5)_t - (ZrO_2)_{1-t}$ , and a solid solution of  $(Ta_2O_5)_u - (HfO_2)_{1-u}$  wherein t and u range from about .09 to less than 1.

### Response to Arguments

6. Applicant's arguments with respect to claims 38-47 and 49-55 have been considered but are most in view of the new ground(s) of rejection.

#### Conclusion

7. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of

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the advisory action. In no event, however, will the statutory period for reply expire later

than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the

examiner should be directed to Ron E. Pompey whose telephone number is (571) 272-

1680. The examiner can normally be reached on compressed.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, Michael S. Lebentritt can be reached on (571) 272-1873. The fax phone

number for the organization where this application or proceeding is assigned is 571-

273-8300.

Information regarding the status of an application may be obtained from the

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Business Center (EBC) at 866-217-9197 (toll-free).

Ron Pompey

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January 20, 2005

MICHAEL LEBENTRITT

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